



#### P-CHANNEL ENHANCEMENT MODE MOSFET

#### **Product Summary**

V <sub>(BR)DSS</sub>	R <sub>DS(ON)</sub> max	I <sub>D</sub> max T <sub>A</sub> = +25°C
	120mΩ @ V <sub>GS</sub> = -4.5V	
-20V	150mΩ @ V <sub>GS</sub> = -2.5V	-3A

### **Features and Benefits**

- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

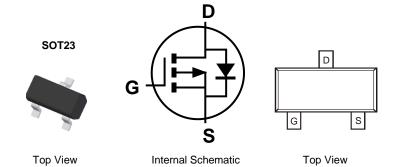
### **Description and Applications**

This MOSFET is designed to minimize the on-state resistance (R<sub>DS(ON)</sub>) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- Backlighting
- Power Management Functions
- DC-DC Converters
- Motor Control

#### **Mechanical Data**

- Case: SOT23
- Case Material: Molded Plastic, "Green" Molding Compound.
  UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 <a>©3</a>
- Terminals Connections: See Diagram Below
- Weight: 0.008 grams (Approximate)



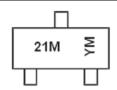
#### **Ordering Information** (Note 4)

Part Number	Case	Packaging
DMG2301L-7	SOT23	3,000/Tape & Reel
DMG2301L-13	SOT23	10,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

#### **Marking Information**



21M = Product Type Marking Code YM = Date Code Marking Y or  $\overline{Y}$  = Year (ex: C = 2015) M = Month (ex: 9 = September)

Date Code Key

Year	201	4	2015		2016	20	17	2018		2019	2	2020
Code	В		С		D	[	=	F		G		Н
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D

DMG2301L Document number: DS37540 Rev. 3 - 2



# Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified)

Characteristic		Symbol	Value	Units
Drain-Source Voltage		$V_{DSS}$	-20	V
Gate-Source Voltage		V <sub>GSS</sub>	±8	V
Continuous Drain Current (Note 5) V <sub>GS</sub> = -4.5V	I <sub>D</sub>	-3 -1	А	
Pulsed Drain Current (Note 6)		I <sub>DM</sub>	-10	Α
Drain-Source Diode Forward Current (t < 5 sec)		Is	-0.75	A

### **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	$P_{D}$	1.5	W
Thermal Resistance, Junction to Ambient @T <sub>A</sub> = +25°C (Note 5)	$R_{\theta JA}$	83	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

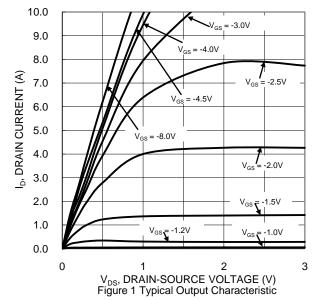
## **Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified)

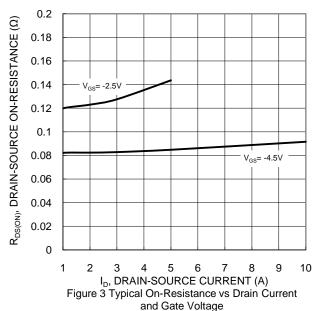
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	-20	_	_	V	$V_{GS} = 0V, I_{D} = -250\mu A$
Zero Gate Voltage Drain Current T <sub>J</sub> = +25°C	I <sub>DSS</sub>	_	_	-1.0	μA	$V_{DS} = -16V, V_{GS} = 0V$
Gate-Source Leakage	I <sub>GSS</sub>	_	_	±100	nA	$V_{GS} = \pm 6V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	$V_{GS(TH)}$	-0.4	_	-1.2	V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$
Static Drain-Source On-Resistance	В			120	mΩ	$V_{GS} = -4.5V$ , $I_{D} = -2.8A$
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>			150	11122	$V_{GS} = -2.5V$ , $I_{D} = -2.0A$
Diode Forward Voltage	$V_{SD}$	_	_	-1.2	V	$V_{GS} = 0V, I_{S} = -0.75A$
DYNAMIC CHARACTERISTICS (Note 8)	DYNAMIC CHARACTERISTICS (Note 8)					
Input Capacitance	C <sub>iss</sub>	_	476	_	pF	101/11/101/
Output Capacitance	Coss	_	53	_	pF	$V_{DS} = -10V, V_{GS} = 0V$ - f = 1.0MHz
Reverse Transfer Capacitance	Crss	_	45	_	pF	I = 1.0WII IZ
Total Gate Charge	$Q_g$	_	5.5	_	nC	
Gate-Source Charge	$Q_gs$	_	0.9		nC	$V_{GS} = -4.5V$ , $V_{DS} = -6V$ , $I_{D} = -2.8A$
Gate-Drain Charge	$Q_{gd}$	_	1.8	_	nC	
Turn-On Delay Time	t <sub>D(ON)</sub>	_	5	_	ns	
Turn-On Rise Time	t <sub>R</sub>	_	10	_	ns	$V_{DS} = -6V, V_{GS} = -4.5V,$
Turn-Off Delay Time	t <sub>D(OFF)</sub>	_	30	_	ns	$R_{GEN} = 6\Omega$ , $I_D = -1A$
Turn-Off Fall Time	t <sub>F</sub>	_	20	_	ns	

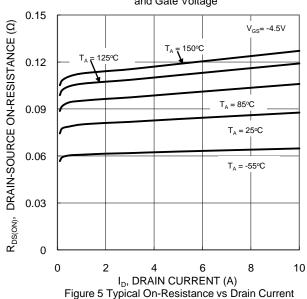
Notes:

- 5. Device mounted on 1" x 1" FR-4 PCB with high coverage 2oz. Copper, single sided.
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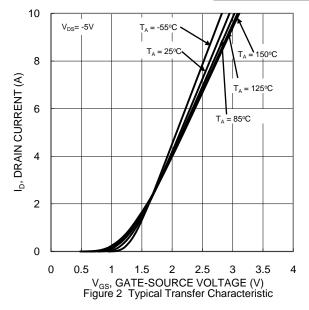


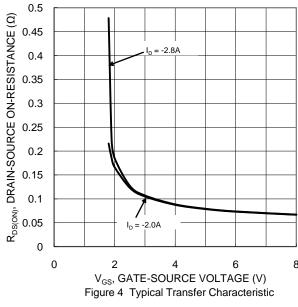


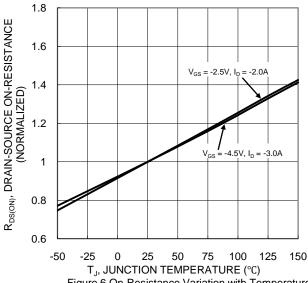


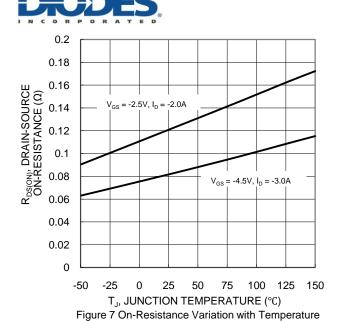


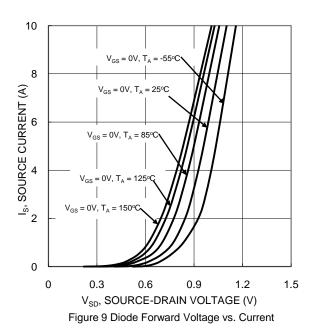
and Temperature

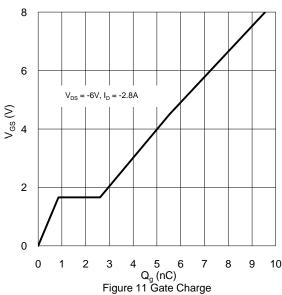












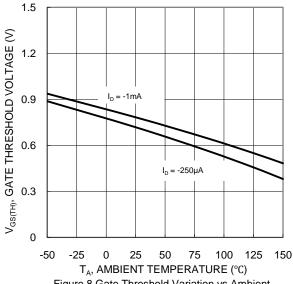
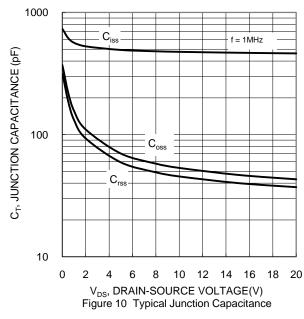
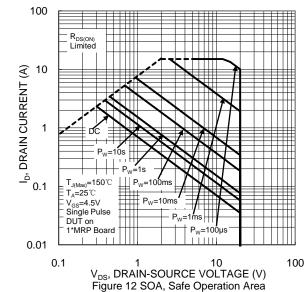
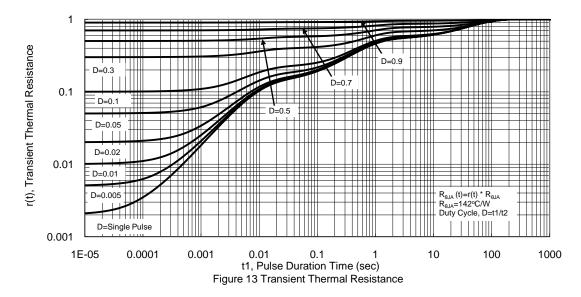


Figure 8 Gate Threshold Variation vs Ambient Temperature



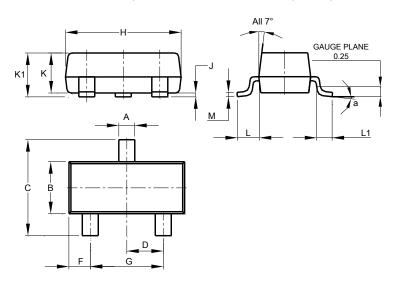






## **Package Outline Dimensions**

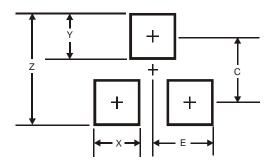
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



SOT23							
Dim	Min	Max	Тур				
Α	0.37	0.51	0.40				
В	1.20	1.40	1.30				
С	2.30	2.50	2.40				
D	0.89	1.03	0.915				
F	0.45	0.60	0.535				
G	1.78	2.05	1.83				
Н	2.80	3.00	2.90				
J	0.013	0.10	0.05				
K	0.890	1.00	0.975				
K1	0.903	1.10	1.025				
L	0.45	0.61	0.55				
L1	0.25	0.55	0.40				
M	0.085	0.150	0.110				
а	8°						
All Dimensions in mm							

## Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
Z	2.9
Х	0.8
Y	0.9
С	2.0
E	1.35



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6 of 6 DMG2301L Document number: DS37540 Rev. 3 - 2

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